

MICRO-OPTICS

INFRARED SOURCES

MASS FLOW DEVICES

LASER GAS DETECTION

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# **EMIRS50 AT06V BC150**

# Thermal MEMS based infrared source

### For direct electrical fast modulation

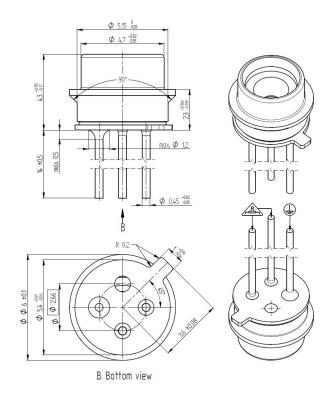
TO46 with Reflector 5

### ■ Infrared Source

Axetris infrared (IR) sources are micro-machined, electrically modulated thermal infrared emitters featuring true blackbody radiation characteristics, low power consumption, high emissivity and a long lifetime. The appropriate design is based on a resistive heating element deposited onto a thin dielectric membrane which is suspended on a micro-machined silicon structure.

# ■ Infrared Gas Detection Applications

- Measurement principles: non-dispersive infrared spectroscopy (NDIR), photoacoustic infrared spectroscopy (PAS) or attenuated-total-reflectance FTIR spectroscopy (ATR)
- Target gases: CO, CO<sub>2</sub>, VOC, NO<sub>X</sub>, NH<sub>3</sub>, SO<sub>X</sub>, SF<sub>6</sub>, hydrocarbons, humidity, anesthetic agents, refrigerants, breath alcohols
- Medical: Capnography, anesthesia gas monitoring, respiration monitoring, pulmonary diagnostics, blood gas analysis
- **Industrial Applications:** Combustible and toxic gas detection, refrigerant monitoring, flame detection, fruit ripening monitoring, SF<sub>6</sub> monitoring, semiconductor fabrication
- **Automotive:** CO<sub>2</sub> automotive refrigerant monitoring, alcohol detection & interlock, cabin air quality
- Environmental: Heating, ventilating and air conditioning (HVAC), indoor air quality and VOC monitoring, air quality monitoring



### ■ Features

- Large modulation depth at high frequencies
- Broad band emission
- Low power consumption
- Long lifetime
- True black body radiation (2 to 14 μm)
- Very fast electrical modulation (no chopper wheel needed)
- Suitable for portable and very small applications
- Rugged MEMS design



## ■ Absolute Maximum Ratings (T<sub>A</sub> = 22°C)

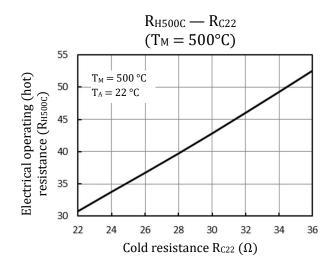
Parameter	Symbol	Rating	Unit
Heater membrane temperature <sup>1</sup>	Тм	500	°C
Optical output power (hemispherical spectral) $(T_M = 500^{\circ}C)$	P <sub>00</sub>	5.0	mW
Optical output power between 4 $\mu$ m and 5 $\mu$ m ( $T_M = 500$ °C)	P <sub>s4.5</sub>	0.73	mW
Optical output power between 6 $\mu$ m and 8 $\mu$ m ( $T_M = 500$ °C)	P <sub>s7.0</sub>	0.95	mW
Optical output power between 8 $\mu$ m and 10 $\mu$ m ( $T_M = 500$ °C)	P <sub>s9.0</sub>	0.58	mW
Optical output power between 10 $\mu$ m and 13 $\mu$ m ( $T_M = 500$ °C)	P <sub>s11.5</sub>	0.48	mW
Electrical cold resistance (at $T_M = T_A = 22$ °C)	R <sub>C22</sub>	22 to 36	Ω
Electrical operating (hot) resistance <sup>2</sup> (at $T_M = 500$ °C with $f = \ge 10$ Hz and $t_{on} \ge 3$ ms)	R <sub>H500C</sub>	1.555 * RC22 - 3.618	Ω
Package temperature	$T_P$	80	°C
Storage temperature	Ts	-20 to +85	°C
Ambient temperature <sup>3</sup> (operation)	T <sub>A</sub>	-40 to +125	°C
Heater area	A <sub>H</sub>	0.8 x 0.8	mm <sup>2</sup>
Frequency <sup>4</sup>	f	10 to 100	Hz

Note: Emission power in this table is defined by hemispherical radiation. Stress beyond those listed under "absolute maximum ratings" may cause permanent damage to the device.

Note: Diagram R<sub>H500C</sub> — R<sub>C22</sub>  $\mid$  (T<sub>M</sub> = 500°C)

How to ensure that the maximum temperature for  $T_M$  is not exceeded:

- 1. Determine electrical cold resistance  $R_{\text{C}}$  of the EMIRS device at TA=22  $^{\circ}\text{C}$
- 2. Ensure that anytime R<sub>H</sub> does not exceed the representative limit as shown in this diagram with respect to these conditions:
  - a.  $f \ge 10 \text{ Hz}$
  - b. on-time (pulse duration)  $\geq 3$  ms



Electrical operating (hot) resistance  $R_H$  versus electrical cold resistance  $R_{C22}$  at  $T_A = 22^{\circ}C$ 

 $<sup>^{\</sup>rm 1}\,\text{Temperatures}$  above 500°C will impact drift and lifetime of the devices.

<sup>&</sup>lt;sup>2</sup> See Diagram  $R_H - R_C \mid (T_M = 500 \degree C)$ 

<sup>&</sup>lt;sup>3</sup> The environmental and package temperature might impact the lifetime and characteristic of the devices.

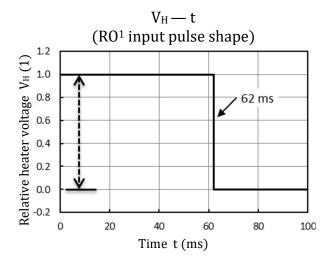
<sup>&</sup>lt;sup>4</sup> Lower cut-off frequency of 10 Hz for designed thermodynamic state. DC drive is also possible but recommended with "soft-off" switch.



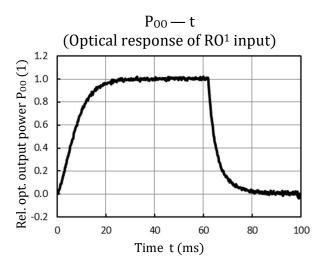
# ■ Ratings at Reference Operation (RO¹ T<sub>A</sub> = 22°C)

Parameter	Symbol	Rating	Unit
Heater membrane temperature	Тм	< 500	°C
Duty cycle of rectangular V <sub>H</sub> pulse	D	62	%
Frequency of rect. pulse shape <sup>2</sup>	$f_{ m ref}$	10	Hz
On time constant of integral emissive power P <sub>00</sub>	$ au_{on}$	10	ms
Off time constant of integral emissive power P <sub>00</sub>	$ au_{ m off}$	5	ms
Package temperature at T <sub>A</sub> = 22°C	TP	40 to 50	°C

Note: First order on-time model using  $\tau_{on}$ : First order off-time model using  $\tau_{off}$ :



Relative rectangular heater voltage ( $V_H$ ) pulse with a relative pulse width of 62 ms at 10 Hz (time description of reference operation  $RO^1$ )



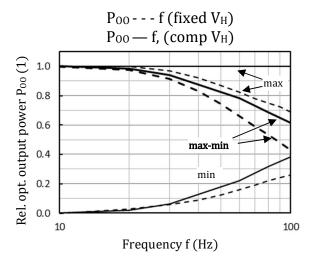
Optical response time (relative optical output power  $P_{00}$ ) of a rectangular voltage pulse ( $RO^1$  conditions)

<sup>&</sup>lt;sup>1</sup> Reference Operation: combines lower cut-off frequency of 10 Hz and maximum modulation depth (max-min signal)

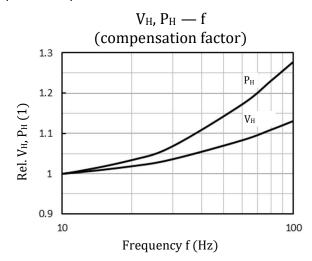
<sup>&</sup>lt;sup>2</sup> Recommended frequencies from 10 Hz to 100 Hz



# ■ Typical Timing Characteristics Frequency (D = 62%)



Relative (to RO) max, min, max-min values of optical output power ( $P_{00}$ ) versus frequency f with fixed and compensated  $V_{\text{H}}$ 



Relative (to RO) electrical drive values heater voltage V<sub>H</sub> and power P<sub>H</sub> versus frequency f for compensation

Note: Diagrams a, b <u>Relative</u>  $P_{00}$ ,  $V_H$ ,  $P_H$  to reference operation (RO) f=10 Hz, rect. pulse D=62%

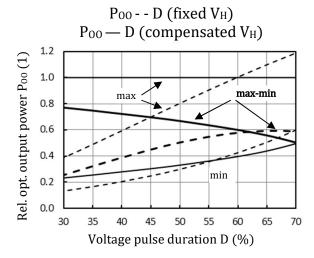
<u>max:</u> maximum value of  $P_{00}$  response shape <u>min:</u> minimum value of  $P_{00}$  response shape <u>max-min:</u> amplitude calculation of  $P_{00}$  resp. shape

Fixed V<sub>H</sub>: same voltage for all frequencies.

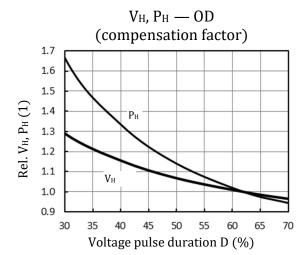
<u>Compensated</u>  $V_H$ : for every frequency value, the voltage is adjusted to achieve the same maximum of  $P_{00}$  response shape as for 10 Hz.



## ■ Typical Timing Characteristics Pulse Duration D¹ (f = 100 Hz)



Relative (to D=62%) max, min, max-min values of optical output power ( $P_{00}$ ) versus duty cycle D with fixed and compensated  $V_{\rm H}$ 



Relative (to RO) electrical drive values heater voltage V<sub>H</sub>, power P<sub>H</sub> versus duty cycle D for compensation

Note: Diagrams a, b

Relative Poo, VH, PH to reference operation (RO)

f=100 Hz, rect. voltage pulse

 $\underline{\text{max:}}$  maximum value of  $P_{00}$  response shape  $\underline{\text{min:}}$  minimum value of  $P_{00}$  response shape  $\underline{\text{max-min:}}$  amplitude calculation of  $P_{00}$  resp. shape

Fixed V<sub>H</sub>: same voltage for all frequencies.

<u>Compensated</u>  $V_H$ : for every frequency value, the voltage is adjusted to achieve the same maximum of  $P_{00}$  response shape as for D=62%.

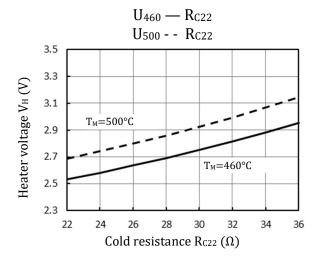
Product Datasheet

<sup>&</sup>lt;sup>1</sup> Effective D shorter than 30% and voltage or power compensation at high frequencies (e.g. 20% @ 100 Hz) might impact the lifetime and characteristic of the devices because of additional stress in material layers.

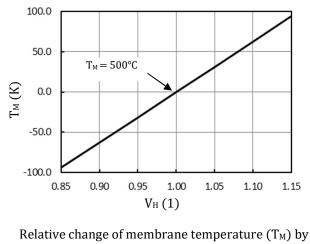


# ■ Typical electrical/thermal characteristics (RO, T<sub>A</sub> = 22°C)

Parameter	Symbol	Rating	Unit
Peak chip membrane temperature	Тм	460	°C
Heater voltage	V <sub>H</sub>	2.69	V
Heater power	P <sub>H</sub>	187	mW

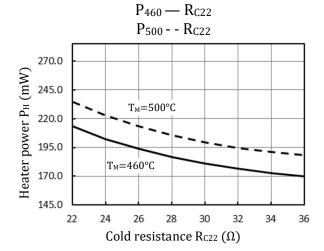


 $Mean^1$  and upper bound of heater voltage  $V_H$  vs. cold resistance RC<sub>22</sub>

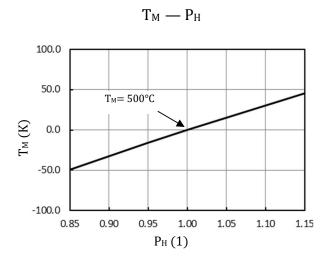


 $T_{\text{M}} - V_{\text{H}}$ 

changing heater voltage (V<sub>H</sub>)



Mean<sup>1</sup> and upper bound of heater power P<sub>H</sub> vs. cold resistance RC22

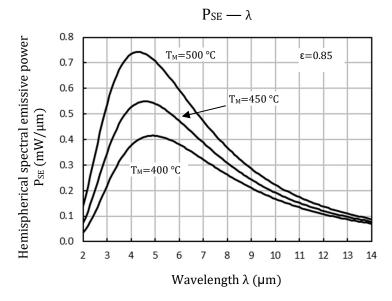


Relative change membrane temperature (T<sub>M</sub>) by changing heater power (PH)

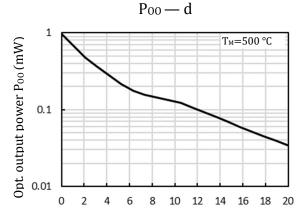
 $<sup>^{1} \,</sup> Recommended \, operation \, mode \, T_{M} = 460^{\circ}C, \, which \, ensures \, 95\% \, confidence \, that \, the \, maximum \, temperature \, T_{M} = 500^{\circ}C \, is \, not \, exceeded.$ 



# ■ Typical Optical Characteristics (RO, T<sub>A</sub> = 22°C)



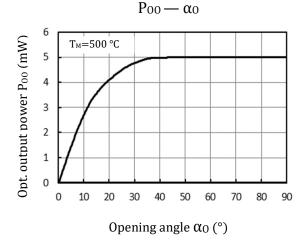
Hemispherical spectral emissive power of EMIRS50 chip surface with a typical emissivity (mean from 2 to 14  $\mu$ m) of  $\epsilon$ =0.85



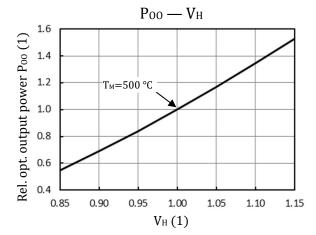
Distance d between EMIRS50 and detector (mm)

Optical output power (P<sub>00</sub>) versus distance d of a

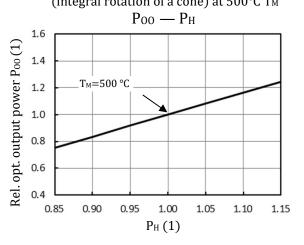
 $1~mm^2$  detection surface at  $500^\circ C~T_M$ 



Optical output power ( $P_{00}$ ) versus opening angle  $\alpha_0$  (integral rotation of a cone) at 500°C  $T_M$ 



Relative change of optical output power  $(P_{00})$  by changing heater voltage  $(V_H)$ 



Relative change of optical output power  $(P_{00})$  by changing heater power  $(P_H)$ 



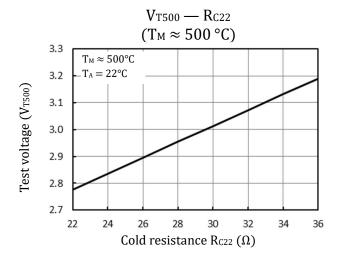
# Specified Ratings at Test Voltage V<sub>T</sub> (on-time ≥ 20 ms, T<sub>H</sub> = T<sub>A</sub> = 22°C)

Parameter	Symbol	Condition	Typical value	Unit
Test voltage (for $T_M \approx 500$ °C)	$V_{\mathrm{T}}$	$T_H = T_A = 22$ °C	0.0295 * RC22 + 2.1271	V
Optical output power (after 20 ms on)	P <sub>00</sub>	after $\geq$ 20 ms $V_T$ on time, $T_P = T_A = 22$ °C	3.20	mW

Note: Other optical output specifications are possible by customer specific requirements (e.g. spectral ranges).

Note: Diagram  $V_{T500C}$  —  $R_{C22}$  |  $(T_M \approx 500^{\circ}C)$  Defined test voltage  $V_T$  for specified ratings:

- 1. Determine electrical cold resistance R<sub>C22</sub> of the EMIRS device at T<sub>A</sub>=22°C
- 2. Drive the device with  $V_T$  for each  $R_C$  as shown in this diagram.
- 3. Ratings are only valid for  $T_P = T_A = 22 \,^{\circ}\text{C}$  and after 20 ms on-time.



Test voltage  $V_T$  versus electrical cold resistance  $R_{C22}$  at  $T_A = 22^{\circ}C$